



DMP2021UFDE

Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
-20V	16mΩ @ V _{GS} = -4.5V	-9.0A
-200	22mΩ @ V _{GS} = -2.5V	-7.7A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- **Battery Management Application**
- **Power Management Functions**
- **DC-DC Converters**

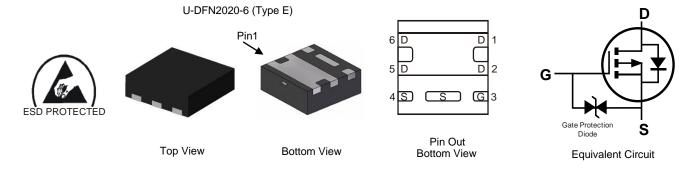
P-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- 0.6mm Profile Ideal for Low Profile Applications
- Low Gate Threshold Voltage
- Low On-Resistance
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: U-DFN2020-6 (Type E)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208 @4)
- Weight: 0.007 grams (Approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
DMP2021UFDE-7	U-DFN2020-6 (Type E)	3,000/Tape & Reel
DMP2021UFDE-13	U-DFN2020-6 (Type E)	10,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



FP = Product Type Marking Code YM = Date Code Marking Y = Year (ex: D = 2016) M = Month (ex: 9 = September)

Date Code Kev

Bate Code Hoj												
Year	201	6	2017		2018	20	19	2020		2021	2	2022
Code	D		E		F	(G	Н				J
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	-20	V		
Gate-Source Voltage	V _{GSS}	±10	V		
Continuous Ducia Current (Nata C) // 4 5//	Steady State	T _A = +25°C T _A = +70°C	ID	-9.0 -7.2	A
Continuous Drain Current (Note 6) $V_{GS} = -4.5V$	t<10s	T _A = +25°C T _A = +70°C	Ι _D	-11.1 -8.9	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	-60	A		
Continuous Source-Drain Diode Current (Note 6)	Is	-2.4	А		
Avalanche Current (Note 7) L = 0.1mH	I _{AS}	-27	А		
Avalanche Energy (Note 7) L = 0.1mH	Eas	38	mJ		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Dawar Dissinction (Nata 5)	T _A = +25°C	D	0.76	W	
Total Power Dissipation (Note 5)	T _A = +70°C	PD	0.48		
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	P	165	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{ extsf{ heta}}JA$	116	C/vv	
Total Power Dissipation (Note 6)	T _A = +25°C	Р	1.90	W	
Total Power Dissipation (Note 6)	T _A = +70°C	PD	1.20	vv	
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	D	67		
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{ extsf{ heta}JA}$	47	°C/W	
Thermal Resistance, Junction to Case (Note 6)	Steady state	$R_{\theta JC}$	18		
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	С°	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

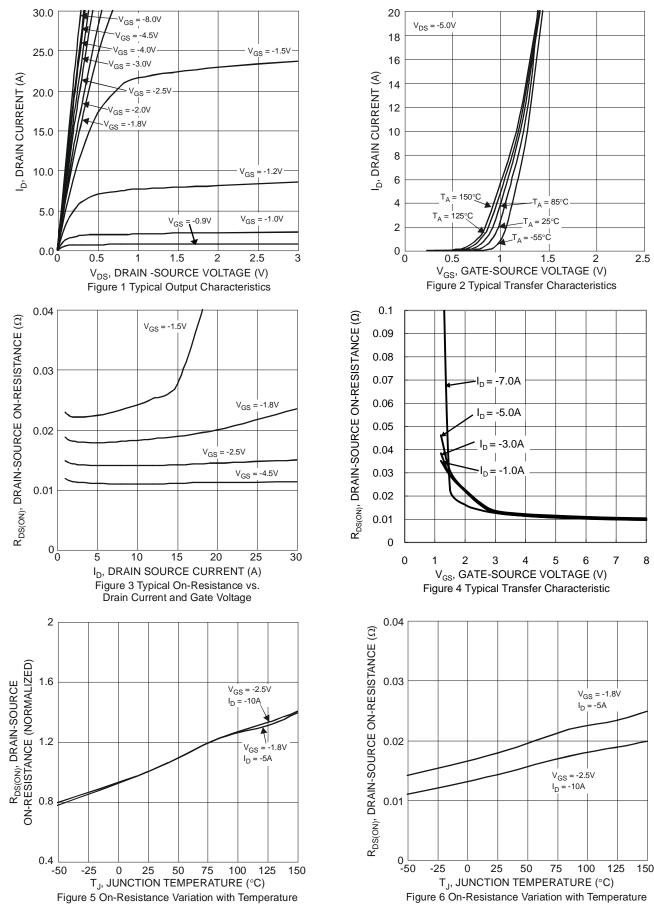
Obernenterietie	O much a l	M	T	M	11-14	To at Oam dition
	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)			r			
Drain-Source Breakdown Voltage	BV _{DSS}	-20	—		V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	_	—	-1	μA	$V_{DS} = -20V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}		—	±10	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	-0.35	—	-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
			12	16		$V_{GS} = -4.5V, I_D = -7.0A$
Static Drain-Source On-Resistance	Р		15	22	mΩ	$V_{GS} = -2.5V, I_D = -5.0A$
	R _{DS(ON)}	_	19	40	11152	$V_{GS} = -1.8V, I_D = -3.0A$
			21	80		$V_{GS} = -1.5V, I_D = -1.0A$
Diode Forward Voltage	V _{SD}	—	-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -1.0A$
DYNAMIC CHARACTERISTICS (Note 9)						-
Input Capacitance	Ciss		2,760	—		
Output Capacitance	C _{oss}	_	262	_	pF	V _{DS} = -15V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	220	—		
Gate Resistance	Rg	_	16	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	34	—		
Total Gate Charge (V _{GS} = -8V)	Qg	—	59	—	nC	
Gate-Source Charge	Q _{gs}	—	3.5	—	nc	$V_{DS} = -15V, I_D = -4.0A$
Gate-Drain Charge	Q _{gd}	_	8.3	—		
Turn-On Delay Time	t _{D(ON)}	_	7.5	—		
Turn-On Rise Time	t _R		25	—		$V_{DS} = -15V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t _{D(OFF)}		125	—	ns	$R_{G} = 1\Omega, I_{D} = -4.0A$
Turn-Off Fall Time	t _F	_	96	—		
Reverse Recovery Time	t _{RR}	_	48	_	ns	I _F = -1.0A, di/dt = 100A/µs
Reverse Recovery Charge	Q _{RR}	_	33	—	nC	I _F = -1.0A, di/dt = 100A/µs

Notes:

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
8. Short duration pulse test used to minimize self-heating effect.
9. Guaranteed by design. Not subject to product testing.



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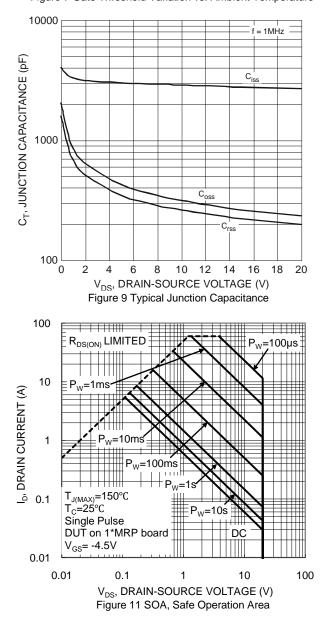


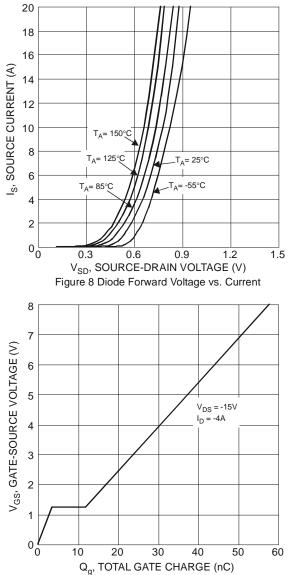
8



0.8 V_{GS(TH)}, GATE THRESHOLD VOLTAGE (V) 0.6 -I_D =1mA 0.4 - I_D= 250µA 0.2 0 ∟ -50 150 -25 50 75 100 125 0 25 T_A, AMBIENT TEMPERATURE (°C)

Figure 7 Gate Threshold Variation vs. Ambient Temperature



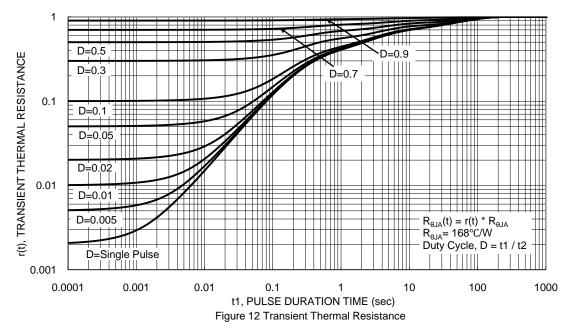


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Figure 10 Gate-Charge Characteristics

DMP2021UFDE Document number: DS38961 Rev. 2 - 2



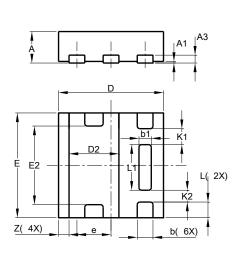




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type E)

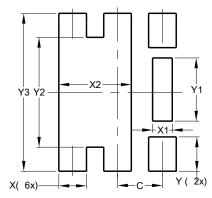


U-DFN2020-6							
Type E							
Dim	Min	Max	Тур				
Α	0.57	0.63	0.60				
A1	0	0.05	0.03				
A3	-	-	0.15				
b	0.25	0.35	0.30				
b1	0.185	0.285	0.235				
D	1.95	2.05	2.00				
D2	0.85	1.05	0.95				
Е	1.95	2.05	2.00				
E2	1.40	1.60	1.50				
e	-	-	0.65				
L	0.25	0.35	0.30				
L1	0.82	0.92	0.87				
K1	-	-	0.305				
K2	-	-	0.225				
Z	_	_	0.20				
All	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type E)



Dimensions	Value				
Dimensions	(in mm)				
С	0.650				
X	0.400				
X1	0.285				
X2	1.050				
Y	0.500				
Y1	0.920				
Y2	1.600				
Y3	2.300				



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